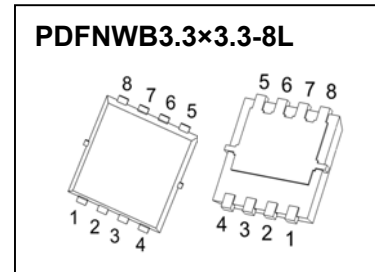




PDFNWB3.3×3.3-8L Plastic-Encapsulate MOSFETS

AB75N03U N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D
30V	2.2mΩ@10V	75A
	3.2mΩ@4.5V	



DESCRIPTION

The AB75N03U uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications

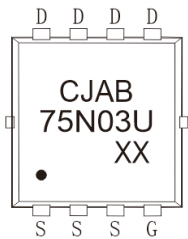
FEATURES

- Battery switch
- Load switch
- High density cell design for ultra low $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

APPLICATIONS

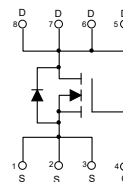
- SMPS and general purpose applications
- Hard switched and high frequency circuits
- Uninterruptible Power Supply

MARKING



AB75N03U = Part No.
 Solid dot = Pin1 indicator
 XX = Code

EQUIVALENT CIRCUIT



ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D ①	75	A
Pulsed Drain Current	I_{DM} ②	300	A
Single Pulsed Avalanche Energy	E_{AS} ③	150	mJ
Maximum Power Dissipation	P_D ④	44	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ⑥	83.3	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$ ①	2.82	°C/W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	°C

MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25\text{ }^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
On characteristics ^④						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.5	2.2	V
Static drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 30A$		2.2	3.0	m Ω
		$V_{GS} = 4.5V, I_D = 30A$		3.2	4.3	m Ω
Dynamic characteristics ^⑤						
Input capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V,$ $f = 1MHz$		3120		pF
Output capacitance	C_{oss}			387		
Reverse transfer capacitance	C_{rss}			319		
Gate resistance	R_g	$f = 1MHz$		4.0		Ω
Switching characteristics ^⑤						
Total gate charge	Q_g	$V_{GS} = 10V,$ $V_{DS} = 15V, I_D = 30A$		49.7		nC
Gate-source charge	Q_{gs}			8.1		
Gate-drain charge	Q_{gd}			11.3		
Turn-on delay time	$t_{d(on)}$	$V_{DS} = 15V, R_L = 2\Omega,$ $V_{GS} = 10V, R_G = 10\Omega$		48		ns
Turn-on rise time	t_r			48		
Turn-off delay time	$t_{d(off)}$			356		
Turn-off fall time	t_f			120		
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	V_{SD} ^④	$V_{GS} = 0V, I_S = 10A$			1.2	V
Continuous drain-source diode forward current	I_S ^①				75	A
Pulsed drain-source diode forward current	I_{SM} ^②				300	A

Notes:

1. $T_C = 25\text{ }^\circ\text{C}$ Limited only by maximum temperature allowed.

2. $P_W \leq 10\mu s$, Duty cycle $\leq 1\%$.

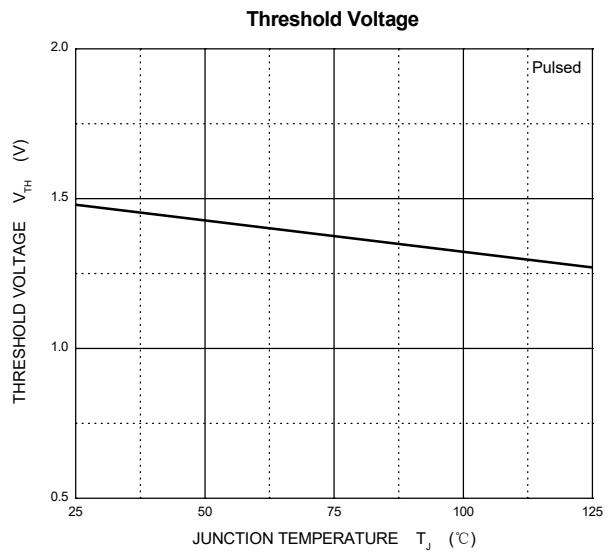
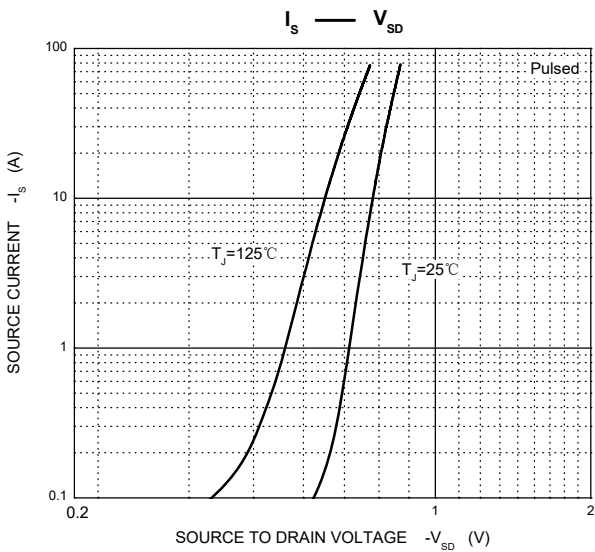
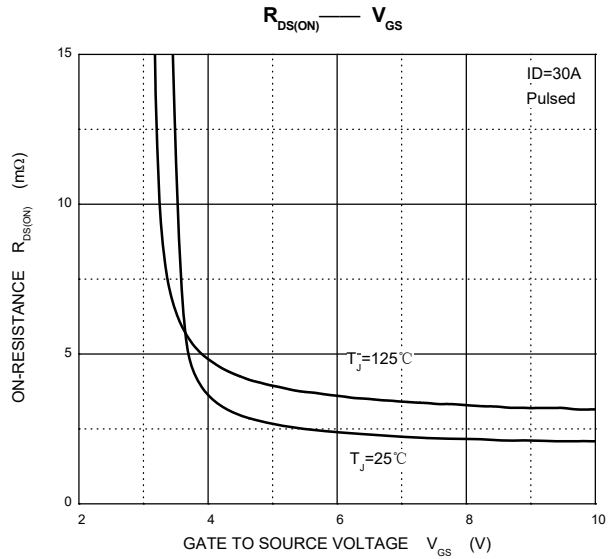
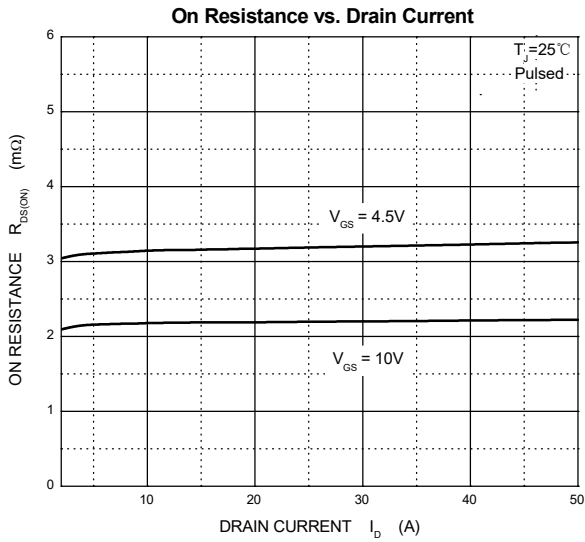
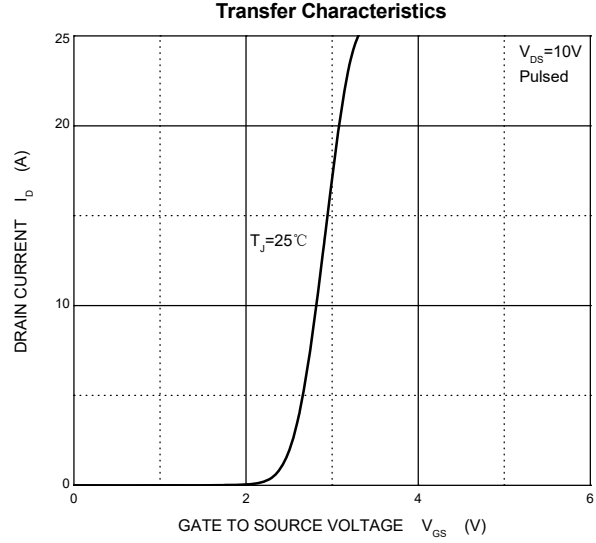
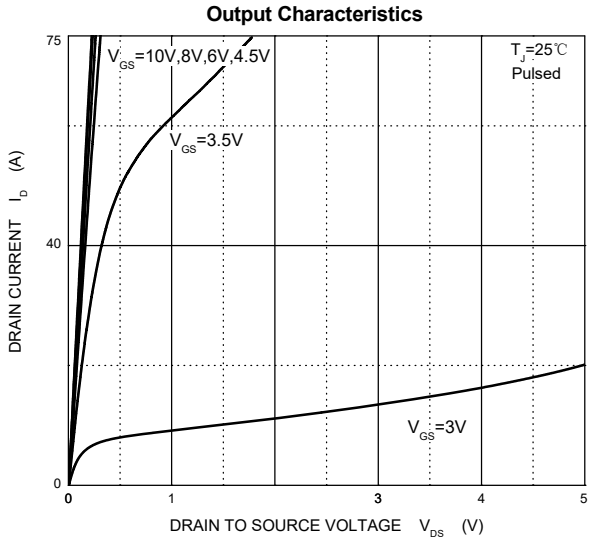
3. EAS condition: $V_{DD} = 15V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega$ Starting $T_J = 25\text{ }^\circ\text{C}$.

4. Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.

5. Guaranteed by design, not subject to production.

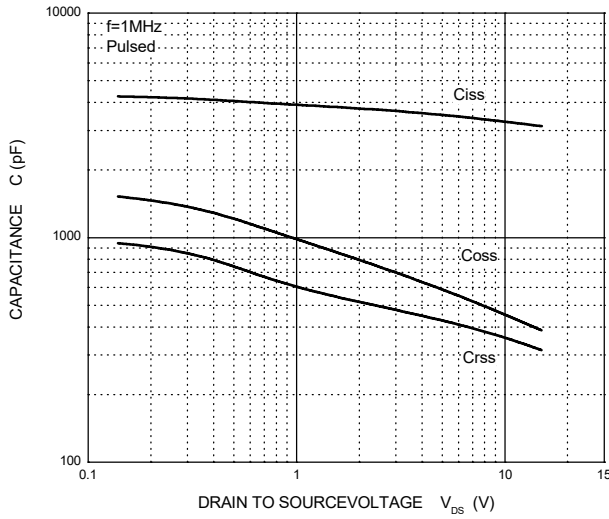
6. The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_a = 25\text{ }^\circ\text{C}$.

Typical Characteristics

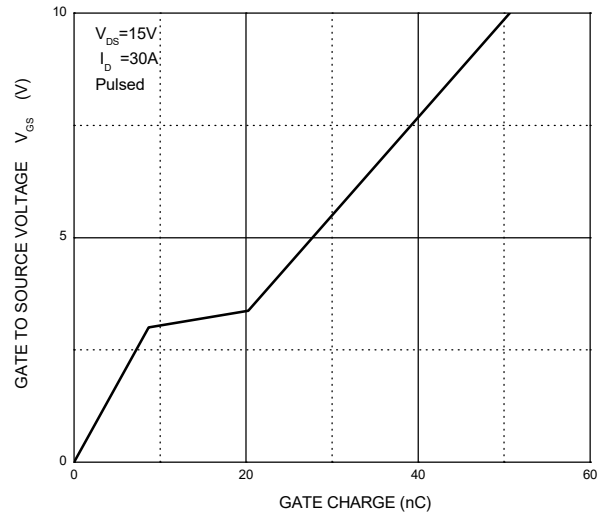


Typical Characteristics

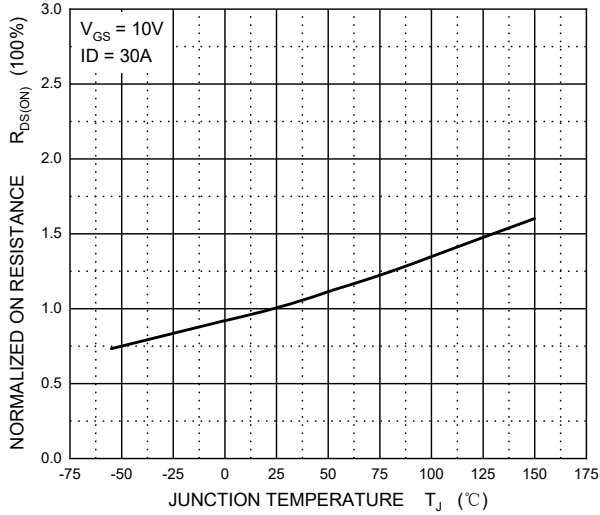
Capacitances



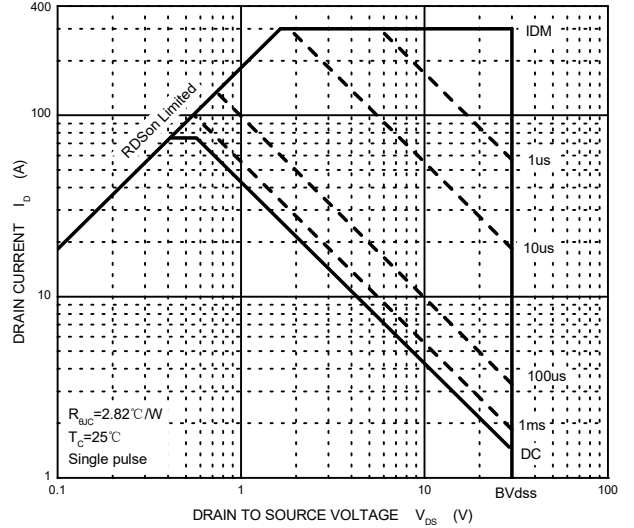
Gate Charge



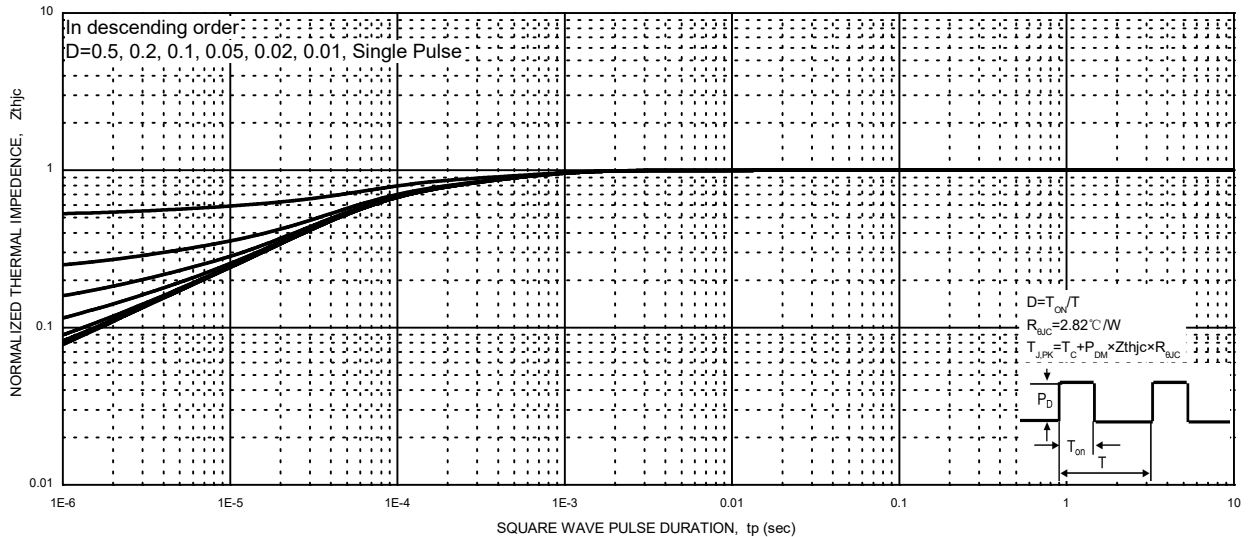
On Resistance vs. Junction Temperature



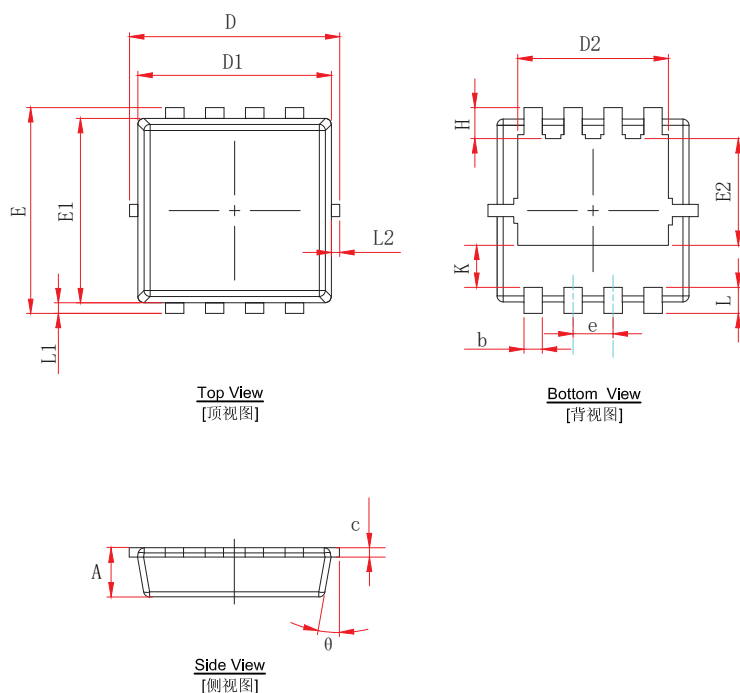
Maximum Forward Biased Safe Operating Area



Normalized Transient Thermal Impedance

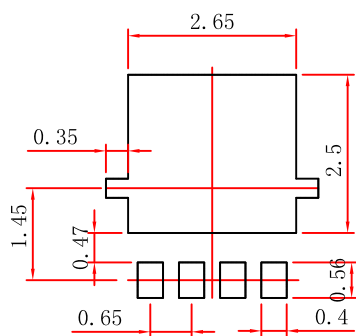


PDFNWB3.3x3.3-8L-E Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
b	0.200	0.400	0.008	0.016
c	0.140	0.250	0.006	0.010
D	3.200	3.400	0.126	0.134
D1	3.000	3.300	0.118	0.130
D2	2.350	2.550	0.093	0.100
e	0.650 BSC		0.026 BSC	
E	3.250	3.450	0.128	0.136
E1	2.850	3.150	0.112	0.124
E2	1.635	1.835	0.064	0.072
H	0.410	0.710	0.016	0.028
K	0.585	0.785	0.023	0.031
L	0.300	0.500	0.012	0.020
L1	0.050	0.250	0.002	0.010
L2	—	0.150	—	0.006
θ	8°	12°	8°	12°

PDFNWB3.3x3.3-8L Suggested Pad Layout

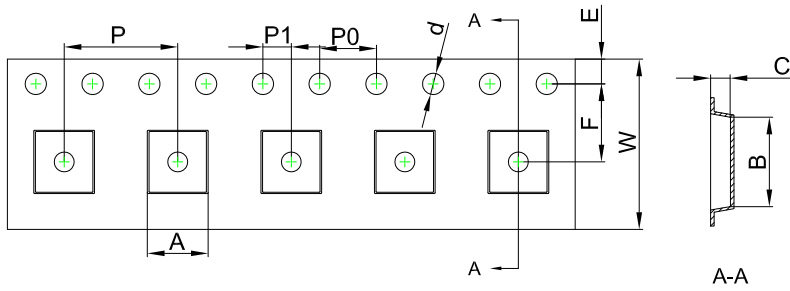


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

PDFNWB3.3×3.3-8L Tape and Reel

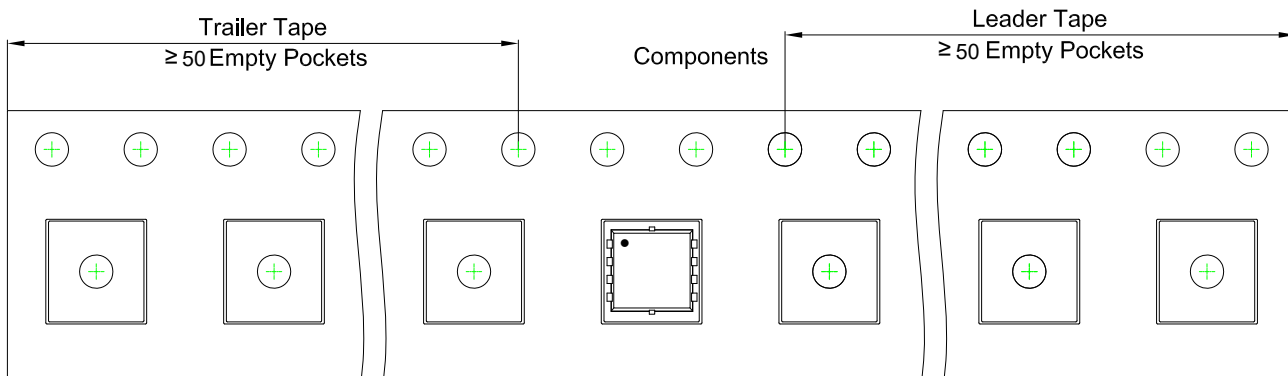
PDFNWB3.3×3.3-8L Embossed Carrier Tape



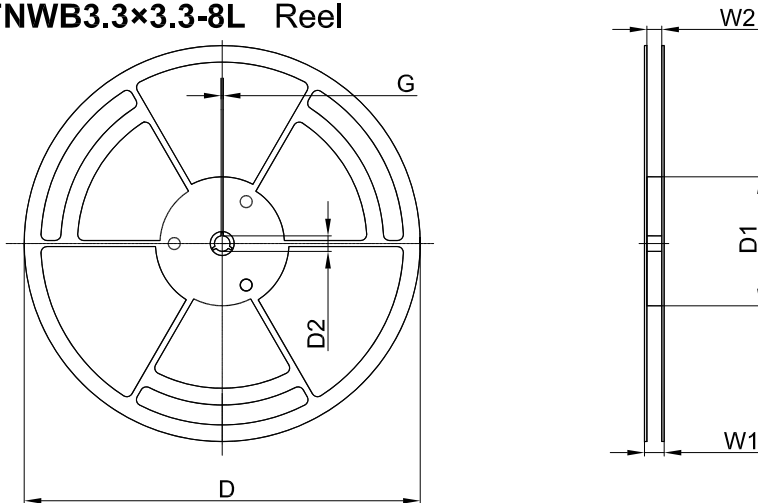
Packaging Description:
PDFNWB3.3x3.3-8L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFNWB3.3×3.3-8L	3.55	3.55	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

PDFNWB3.3×3.3-8L Tape Leader and Trailer



PDFNWB3.3×3.3-8L Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13" Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365